

100V N-Channel Enhancement Mode MOSFET

Description

The AP150N10NF uses advanced APM-SGTII technology

to provide excellent R_{DS(ON)}, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a Battery protection or

in other Switching application.

General Features

V_{DS} = 100V I_D =150A

R_{DS(ON)} < 4.5mΩ @ V_{GS}=10V (Type: 4.0mΩ)

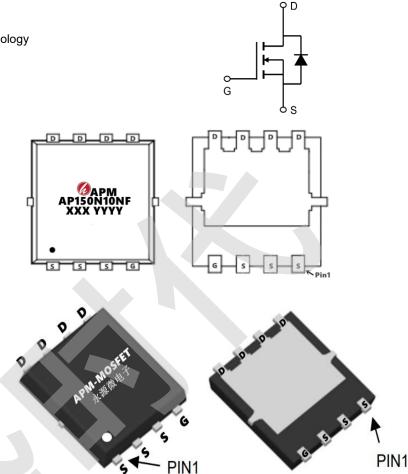
Application

Isolated DC

Motor control

Synchronous-rectification

Clip packaging process



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP120N10NF	PDFN5*6-8L	AP120N10NF XXX YYYY	5000

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	100	V
VGS	Gate-Source Voltage ±20		V
I _D @T _A =25℃	Continuous Drain Current ¹	150	А
I₀@T _A =70°C	Continuous Drain Current ¹	96	А
IDM	Pulsed Drain Current ²	480	А
EAS	Single Pulse Avalanche Energy ³	320	mJ
IAS	Avalanche Current	40	А
P _D @T _A =25°C	Total Power Dissipation ⁴	131.6	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-Ambient ¹	25	°C/W
R₀JC	Thermal Resistance Junction-Case ¹	0.95	°C/W



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Electrical Characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	100	107	-	V
IGSS	Gate-body Leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
1000	Zero Gate Voltage Drain Current TJ=25°C		-	-	1	μA
IDSS	Zero Gate Voltage Drain Current TJ=100°C	$V_{DS} = 100 V, V_{GS} = 0 V$	-	-	100	
VGS(th)	Gate-Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2.0	3.0	4.0	V
RDS(on)	Drain-Source on-Resistance ⁴	V _{GS} = 10V, I _D = 20A	-	4.1	4.5	mΩ
gfs	Forward Transconductance ⁴	V _{DS} = 10V, I _D = 20A	-	62	-	S
Ciss	Input Capacitance		-	6865	-	
Coss	Output Capacitance	$V_{DS} = 50V, V_{GS} = 0V,$ f =1MHz	-	740	-	pF
Crss	Reverse Transfer Capacitance		-	21	_	
Rg	Gate Resistance	f =1MHz	-	1.3	-	Ω
Qg	Total Gate Charge		-	111.2	-	
Qgs	Gate-Source Charge	$V_{GS} = 10V, V_{DS} = 50V,$ $I_{D}=20A$	-	30.5	-	nC
Qgd	Gate-Drain Charge		-	27.3	-	
td(on)	Turn-on Delay Time		-	33	-	
tr	Rise Time	V _{GS} =10V, V _{DD} =50V, R _G =	-	39	-	20
td(off)	Turn-off Delay Time	3Ω, I _D = 20A	-	67.1	-	ns
t _f	Fall Time		-	32	-	
trr	Body Diode Reverse Recovery Time	I _F = 20A, dI/dt=100A/µs	-	58.7	-	ns
Qrr	Body Diode Reverse Recovery Charge		I	97.3	-	nC
VSD	Diode Forward Voltage ⁴	Is = 20A, V _{GS} = 0V	-	-	1.2	V
IS	Continuous Source Current Tc=25°C	-	-	-	120	Α

Note :

 $1_{\,\rm V}\,$ The data tested by surface mounted on a 1 inch 2 $\,$ FR-4 board with 2OZ copper.

 $2\,{\scriptstyle \sim}\,$ The data tested by pulsed , pulse width $\leq 300 us$, duty cycle $\leq 2\%$

3、The EAS data shows Max. rating . The test condition is VDD=72V,VGS=10V, L=0.1mH IAS=40A

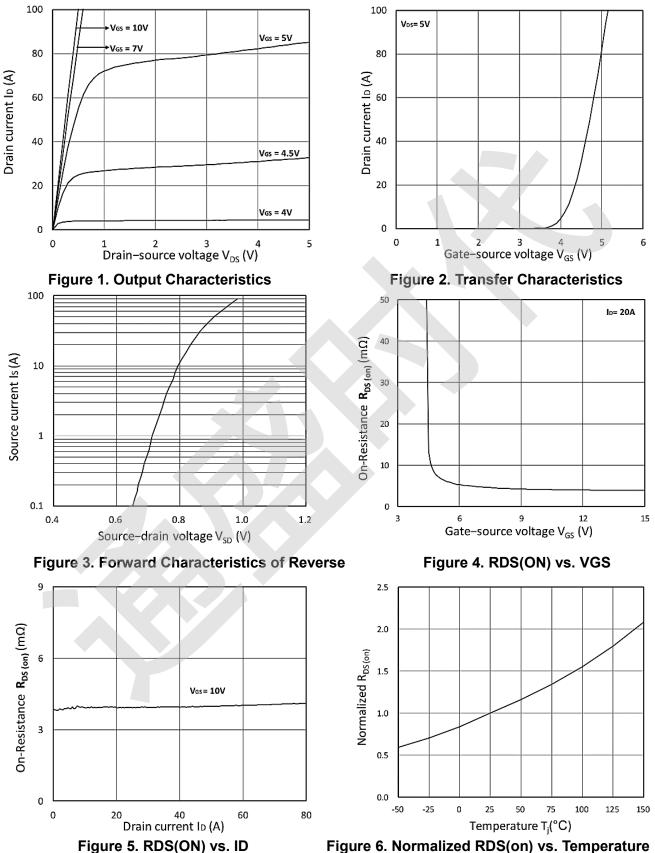
4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I D and I DM, in real applications, should be limited by total power dissipation



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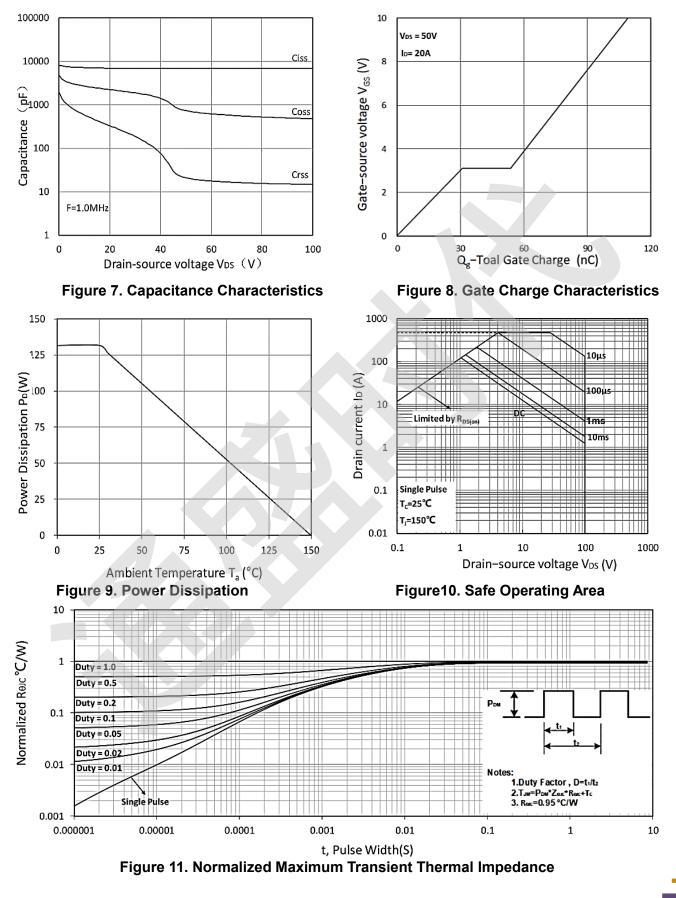
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Typical Characteristics



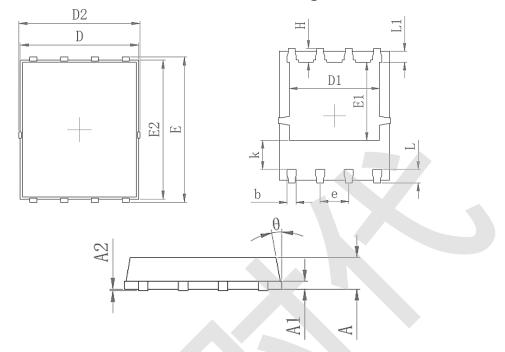
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Package Mechanical Data-PDFN5X6-8L-XZT Single



	Symbol mm		
Symbol			
	Mim	Max	
А	0.90	1.10	
A1	0.254	0.254 REF	
A2	0-0.	0-0.05	
D	4.824	4.976	
D1	3.910	4.110	
D2	4.944	5.076	
E	5.924	6.076	
E1	3.375	3.575	
E2	5.674	5.826	
b	0.350	0.450	
e	1.270		
L	0.534	0.686	
L1	0.424	0.576	
К	1.190	1.390	
Н	0.549	0.701	
Φ	8°	12°	



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Edition	Date	Change
Rve1.0	2021/1/31	Initial release

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